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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10064500	FILING DATE 07/22/2002	CLASS 219	SUBCLASS 678.000	GAU 3742	EXAMINER Van
**APPLICANTS: Barmatz Martin; Mai John; Jackson Henry; Budraa Nasser; Pike William; 678.000					
**CONTINUING DATA VERIFIED: No					
** FOREIGN APPLICATIONS VERIFIED: No					
PG-PUB <input type="checkbox"/> DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed 35 USC 119 conditions met Verified and Acknowledged Examiners's initials		<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> yes <input checked="" type="checkbox"/> no		ATTORNEY DOCKET NO 06618/891001 / CIT 2969 C	
TITLE : Microwave bonding of thin film metal coated substrates					

U.S. DEPT. OF COMM/PAT. & TM-PTO-436L(Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		Assistant Examiner		CLAIMS ALLOWED	
				Total Claims	Print Claim for O.G.
ISSUE FEE		Primary Examiner	DRAWING		
Amount Due	Date Paid		Sheets Drwg.	Figs. Drwg.	Print Fig.
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Application Examiner		
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